Sony Mobile Communications, Inc.

4-12-3 Higashi-shinagawa, Shinagawa-ku, Tokyo, 140-0002, Japan

Remarks

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Date: January 16, 2018

Internal Photos

FCC: **PY7-77587P**

1. Remove Pad Front cover





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2. Remove the Cabinet





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3. PCB and Chassis with Fan



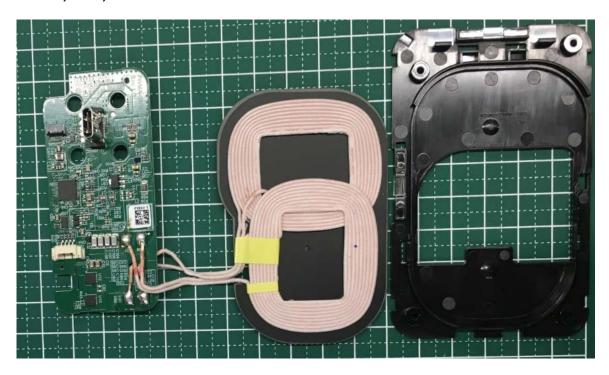
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4. PCB, Coil, and Cover Front





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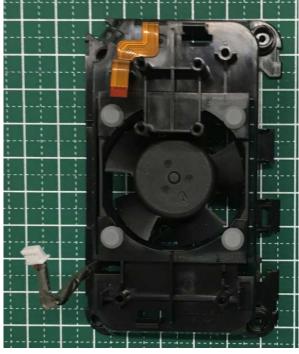
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5. Fan with Chassis





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